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FORM PTO-1595 U.S. DEPARTMENT OF CO 1-31-92  6715/57605  To the Honorable Commission 101196609	514 Rec'd PCT/PTO atercano Trace ark of 2000 OVER SHEET  NLY  original documents or copy thereof.  Name and address of receiving party(ies):
1. Name of conveying party(ies).  Toru Sasaki, Kaoru Gyotoku, Kohei Asada  Aditional name(s) of conveying party(ies) attached? Yes No	Name: Sony Corporation Internal Address:
3. Nature of Conveyance:  X Assignment	Street Address: 7-35 Kitashinagawa 6-chome Shinagawa-ku, Tokyo, Japan  City State ZIP
Execution Date: August 24 and 26, 1999  4. Application number(s) or patent number(s):  If this document is being filed together with a new application, the execution date of A. Patent Application No.(s)	Additional name(s) & address(es) attached? Yes No  the application is: September 8, 1999  B. Patent No.(s)
Additional numbers attached  5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Jay H. Maioli Internal Address: Cooper & Dunham LLP	7. Total fee (37 CFR 3.41):\$ 40.00 E
Street Address:1185 Avenue of the Americas  City: New York	8. Deposit account number:  03-3125 duplicate copy of this page if paying by deposit account)  (Attach
	TAYO CIDA CIP
To the best of my knowledge and belief, the foregoing informative original document.  Jay H. Maioli, Reg. No. 27,213  Name of Person Signing  Name of Person Signing  Name of Person Signing	nation is true and correct and any attached copy is a true copy of  September 8, 1999  Date
OMB No. 0651-0011 (exp. 4/94)	Total Number of pages comprising cover sheet:
Do not detach  Mail documents to be recorded with required cover sheet information to:  Commissioner of Pate Box Assig	nts and Trademarks
Washington, I  Public burden reporting for this sample cover sheet is estimated to average reviewing the document and gathering the data needed, and completing an this burden estimate to the U.S. Patent and Trademark Office, Office of In the office of Management and Budget, Paperwork Reduction Project. (065)	D.C. 20231  about 30 minutes per document to be recorded, including time for d reviewing the sample cover sheet. Send comments regarding formation Systems, PK2-1000C, Washington, D.C. 20231, and to

PATENT REEL: 010362 FRAME: 0421

Docket No	
Docket No	

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

LOUDSPEAKER AND METHOD OF DRIVING THE SAME AS WELL AS AUDIO SIGNAL TRANSMITTING/RECEIVING APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, <u>Sony Corporation</u>, a <u>Japanese corporation</u> with offices at <u>7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001 Japan</u> (hereinafter reference as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereof;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and

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Docket	No.		

said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereof;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

> International Application Number PCT/JP98/06008 International Filing Date December 28, 1998 U.S. Serial Number \_\_\_\_\_\_U.S. Filing Date \_\_\_\_\_\_

This assignment executed on the dates indicated below.

Toru Sasaki	
Name of first or sole inventor	Date
Tokyo, Japan	August 24, 1999
Residence of first or sole inventor	
Toru Sasaki	
Signature of first or sole inventor	Execution date of U.S. Patent Application
Kaoru Gyotoku Name of second inventor	Date
wante of second inventor	
Kanagawa, Japan	August 24, 1999
Residence of second inventor	
Kaoru Quotoku	
Signature of second inventor	Execution date of U.S. Patent Application
Kohei Asada	Data
Name of third inventor	Date
Tokyo Japan	August 26, 1999
Tokyo, Japan Residence of third inventor	d
W. 1 . 1 . 1 .	
Signature of third inventor	Execution date of U.S. Patent Application

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RECORDED: 09/08/1999